

MC74VHCT74A

Dual D-Type Flip-Flop with Set and Reset

The MC74VHCT74A is an advanced high speed CMOS D-type flip-flop fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The signal level applied to the D input is transferred to Q output during the positive going transition of the Clock pulse.

Reset ($\overline{RD}$) and Set ($\overline{SD}$) are independent of the Clock (CP) and are accomplished by setting the appropriate input Low.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7 V, allowing the interface of 5 V systems to 3 V systems.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5 V CMOS level output swings.

The VHCT74A input structures provide protection when voltages between 0 V and 5.5 V are applied, regardless of the supply voltage. The output structures also provide protection when $V_{CC} = 0$ V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

- High Speed: $f_{max} = 60$ MHz (Typ) at $V_{CC} = 5$ V
- Low Power Dissipation: $I_{CC} = 2$ μ A (Max) at $T_A = 25^\circ$ C
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 4.5 V to 5.5 V Operating Range
- Low Noise: $V_{OLP} = 0.8$ V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 128 FETs or 32 Equivalent Gates



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D SUFFIX
14-LEAD SOIC PACKAGE
CASE 751A



DT SUFFIX
14-LEAD TSSOP PACKAGE
CASE 948G



M SUFFIX
14-LEAD SOIC EIAJ PACKAGE
CASE 965

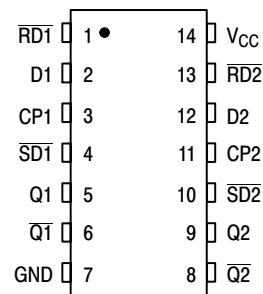


Figure 1. Pin Assignment

ORDERING INFORMATION

Device	Package	Shipping
MC74VHCTXXAD	SOIC	55 Rail
MC74VHCTXXADT	TSSOP	96 Rail

MC74VHCT74A

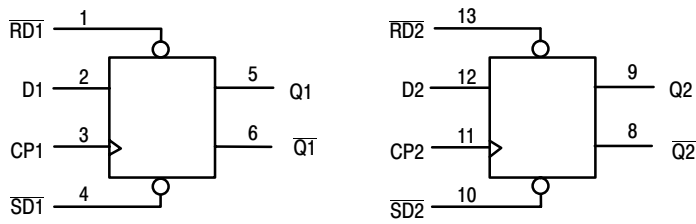


Figure 2. Logic Diagram

FUNCTION TABLE					
Inputs				Outputs	
SD	RD	CP	D	Q	$\bar{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H*	H*
H	H	$\nearrow$	H	H	L
H	H	$\searrow$	L	L	H
H	H	L	X	No Change	No Change
H	H	H	X	No Change	No Change
H	H	$\curvearrowright$	X	No Change	No Change

*Both outputs will remain high as long as Set and Reset are low, but the output states are unpredictable if Set and Reset go high simultaneously.

MC74VHCT74A

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	−0.5 to +7.0	V
V_{in}	DC Input Voltage	−0.5 to +7.0	V
V_{out}	DC Output Voltage $V_{CC} = 0$ High or Low State	−0.5 to +7.0 −0.5 to $V_{CC} + 0.5$	V
I_{IK}	Input Diode Current	−20	mA
I_{OK}	Output Diode Current ($V_{OUT} < GND$; $V_{OUT} > V_{CC}$)	±20	mA
I_{out}	DC Output Current, per Pin	±25	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	±50	mA
P_D	Power Dissipation in Still Air, SOIC Packages† TSSOP Package†	500 450	mW
T_{stg}	Storage Temperature	−65 to +150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

† Derating – SOIC Packages: −7 mW/°C from 65° to 125°C
TSSOP Package: −6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CC}	DC Supply Voltage	4.5	5.5	V
V_{in}	DC Input Voltage	0	5.5	V
V_{out}	DC Output Voltage $V_{CC} = 0$ High or Low State	0 0	5.5 V_{CC}	V
T_A	Operating Temperature	−40	+85	°C
t_r, t_f	Input Rise and Fall Time $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	0	20	ns/V

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V_{CC} V	$T_A = 25^\circ\text{C}$			$T_A = -40 \text{ to } 85^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
V_{IH}	Minimum High-Level Input Voltage		4.5 to 5.5	2.0			2.0		V
V_{IL}	Maximum Low-Level Input Voltage		4.5 to 5.5			0.8		0.8	V
V_{OH}	Minimum High-Level Output Voltage $V_{in} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -50 \mu\text{A}$	4.5	4.4	4.5		4.4		V
		$I_{OH} = -8 \text{ mA}$	4.5	3.94			3.80		
V_{OL}	Maximum Low-Level Output Voltage $V_{in} = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 50 \mu\text{A}$	4.5		0.0	0.1		0.1	V
		$I_{OL} = 8 \text{ mA}$	4.5			0.36		0.44	
I_{in}	Maximum Input Leakage Current	$V_{in} = 5.5 \text{ V or GND}$	0 to 5.5			±0.1		±1.0	μA
I_{CC}	Maximum Quiescent Supply Current	$V_{in} = V_{CC} \text{ or GND}$	5.5			2.0		20.0	μA
I_{CCT}	Quiescent Supply Current	Per Input: $V_{IN} = 3.4 \text{ V}$ Other Input: $V_{CC} \text{ or GND}$	5.5			1.35		1.50	mA
I_{OPD}	Output Leakage Current	$V_{OUT} = 5.5 \text{ V}$	0			0.5		5.0	μA

MC74VHCT74A

AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0\text{ns}$)

Symbol	Parameter	Test Conditions	$T_A = 25^\circ\text{C}$			$T_A = -40 \text{ to } 85^\circ\text{C}$		Unit
			Min	Typ	Max	Min	Max	
t_{PLH} , t_{PHL}	Maximum Propagation Delay, CP to Q or $\bar{Q}$	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$		5.8 6.3	7.8 8.8	1.0 1.0	9.0 10.0	ns
t_{PLH} , t_{PHL}	Maximum Propagation Delay, $\bar{SD}$ or $\bar{RD}$ to Q or $\bar{Q}$	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$		7.6 8.1	10.4 11.4	1.0 1.0	12.0 13.0	ns
f_{max}	Maximum Clock Frequency (50% Duty Cycle)	$V_{CC} = 5.0 \pm 0.5\text{V}$ $C_L = 15\text{ pF}$ $C_L = 50\text{ pF}$	100 80	160 140		80 65		MHz
C_{in}	Maximum Input Capacitance			4	10		10	pF

C_{PD}	Power Dissipation Capacitance (Note 1.)	Typical @ 25°C , $V_{CC} = 5.0\text{ V}$	pF
		24	

1. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \cdot V_{CC} \cdot f_{in} + I_{CC}/2$ (per flip-flop). C_{PD} is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_{in} + I_{CC} \cdot V_{CC}$.

TIMING REQUIREMENTS (Input $t_r = t_f = 3.0\text{ ns}$)

Symbol	Parameter	V_{CC} V	Guaranteed Limit		Unit
			$T_A = 25^\circ\text{C}$	$T_A = -40 \text{ to } 85^\circ\text{C}$	
t_w	Minimum Pulse Width, CP	5.0 ± 0.5	5.0	5.0	ns
t_w	Minimum Pulse Width, $\bar{RD}$ or $\bar{SD}$	5.0 ± 0.5	5.0	5.0	ns
t_{su}	Minimum Setup Time, D to CP	5.0 ± 0.5	5.0	5.0	ns
t_h	Minimum Hold Time, D to CP	5.0 ± 0.5	0.0	0.0	ns
t_{rec}	Minimum Recovery Time, $\bar{SD}$ or $\bar{RD}$ to CP	5.0 ± 0.5	3.5	3.5	ns

MC74VHCT74A

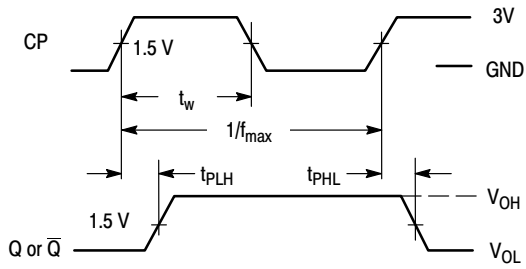


Figure 3. Switching Waveform

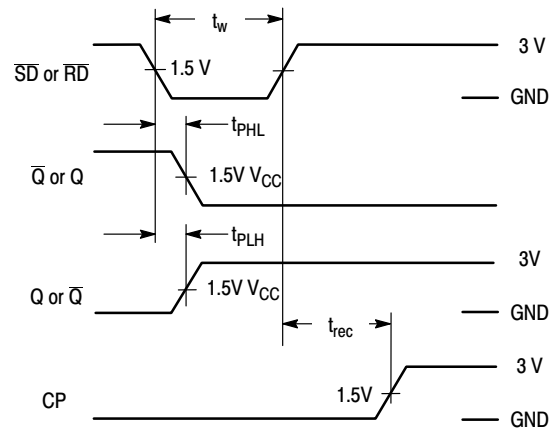


Figure 4. Switching Waveform

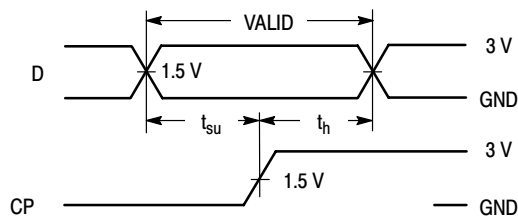
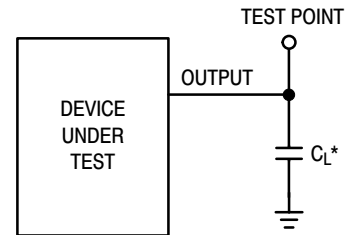


Figure 5. Switching Waveform



*Includes all probe and jig capacitance

Figure 6. Switching Waveform

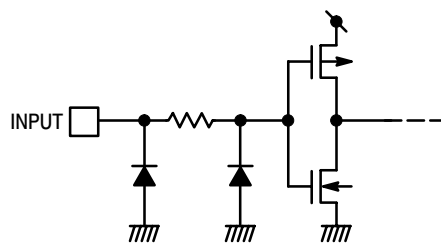
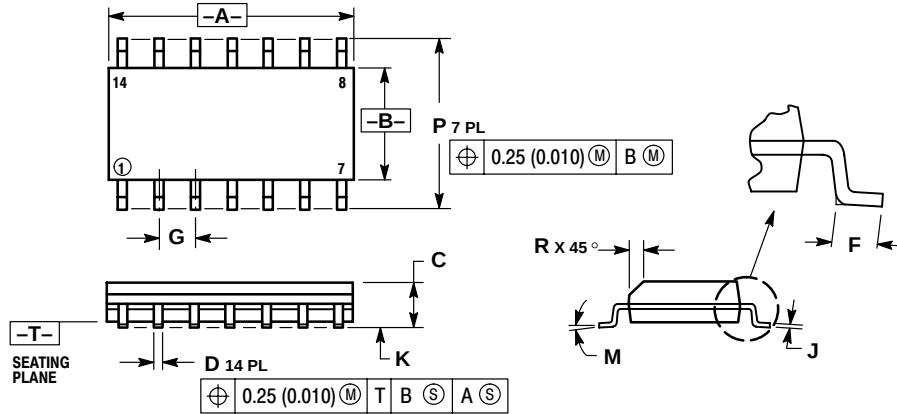


Figure 7. Input Equivalent Circuit

MC74VHCT74A

OUTLINE DIMENSIONS

D SUFFIX SOIC-14 CASE 751A-03 ISSUE F



NOTES:

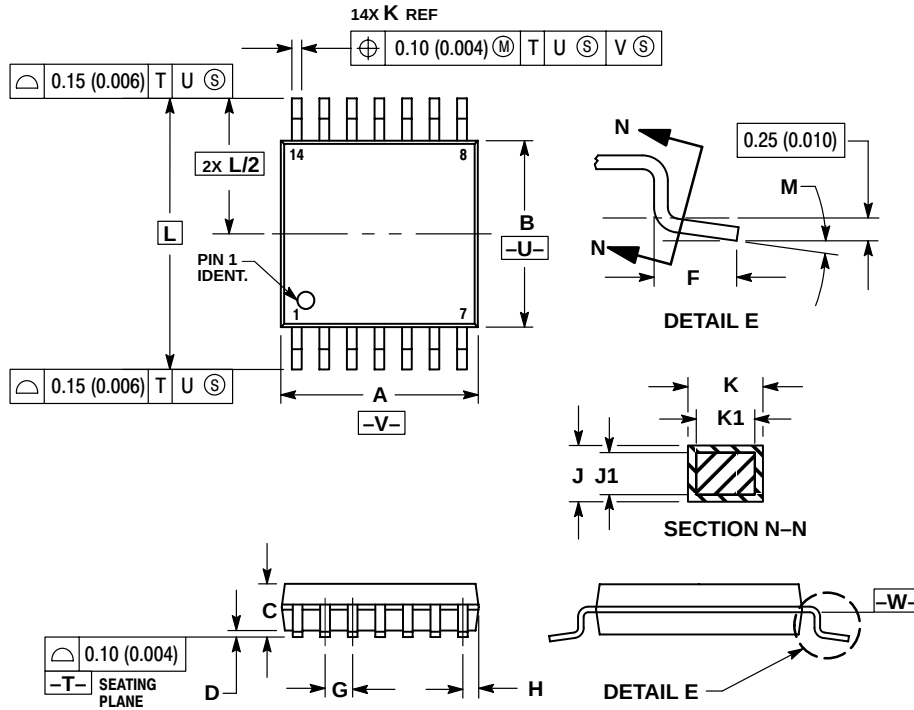
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

MC74VHCT74A

OUTLINE DIMENSIONS

DT SUFFIX
TSSOP
CASE 948G-01
ISSUE O



NOTES:

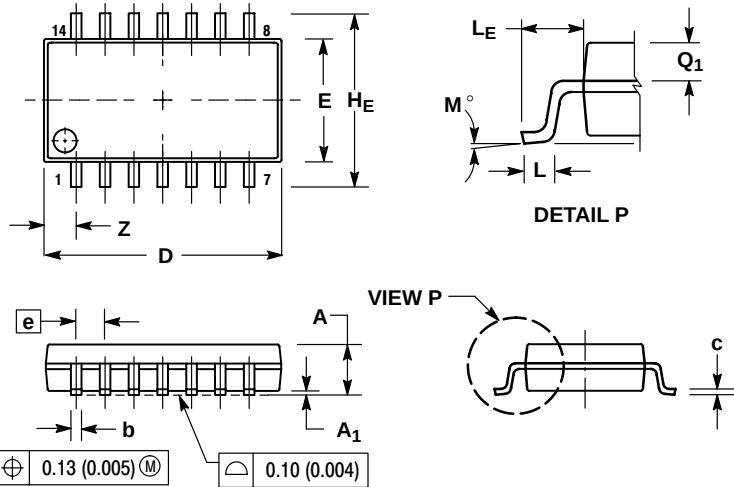
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

MC74VHCT74A

OUTLINE DIMENSIONS

**M SUFFIX
SO-14
CASE 965-01
ISSUE O**



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H _E	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

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